INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Application Number	10612061	
	Filing Date	2003-06-30	
	First Named Inventor	Eric L. Debes	
	Art Unit	2193	
	Examiner Name	Malzahn, David H.	
	Attorney Docket Number	42P15765	

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	9	INTEL CORPORATION, "i860 TM Microprocessor Family Programmer's Reference Manual," 1992, Chapters 1, 3, 8 and 11	☐
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